

**Electronic Patent Application Fee Transmittal**

<b>Application Number:</b>	10561839			
<b>Filing Date:</b>	05-Jun-2006			
<b>Title of Invention:</b>	Materials for constructing cell-chips, cell-chip covers, cell-chips coats, processed cell-chips and uses thereof			
<b>First Named Inventor/Applicant Name:</b>	Mordechai Deutsch			
<b>Filer:</b>	Jason Harris Rosenblum/dorit handrus			
<b>Attorney Docket Number:</b>	30024			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Submission- Information Disclosure Stmt	1806	1	180	180
<b>Total in USD (\$)</b>				<b>180</b>